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What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Obsolete
Core Processor	F²MC-16FX
Core Size	16-Bit
Speed	32MHz
Connectivity	LINbus, SCI, UART/USART
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	37
Program Memory Size	160KB (160K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	10K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	A/D 16x8/10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-LQFP (7x7)
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/mb96f615abpmc-gse2

Built-in On Chip Debugger (OCD)

- One-wire debug tool interface
- Break function:
  - Hardware break: 6 points (shared with code event)
  - Software break: 4096 points
- Event function
  - Code event: 6 points (shared with hardware break)
  - Data event: 6 points
  - Event sequencer: 2 levels + reset
- Execution time measurement function
- Trace function: 42 branches
- Security function

Flash Memory

- Dual operation flash allowing reading of one Flash bank while programming or erasing the other bank
- Command sequencer for automatic execution of programming algorithm and for supporting DMA for programming of the Flash Memory
- Supports automatic programming, Embedded Algorithm
- Write/Erase/Erase-Suspend/Resume commands
- A flag indicating completion of the automatic algorithm
- Erase can be performed on each sector individually
- Sector protection
- Flash Security feature to protect the content of the Flash
- Low voltage detection during Flash erase or write

1. Product Lineup

Features		CY96610	Remark
Product Type		Flash Memory Product	
Subclock		Subclock can be set by software	
Dual Operation Flash Memory	RAM	-	
32.5KB + 32KB	4KB	CY96F612R, CY96F612A	Product Options R: MCU with CAN A: MCU without CAN
64.5KB + 32KB	10KB	CY96F613R, CY96F613A	
128.5KB + 32KB	10KB	CY96F615R, CY96F615A	
Package		LQFP-48 LQA048	
DMA		2ch	
USART		3ch	LIN-USART 2/7/8
	with automatic LIN-Header transmission/reception	Yes (only 1ch)	LIN-USART 2
	with 16 byte RX- and TX-FIFO	No	
8/10-bit A/D Converter		16ch	AN 0/1/3/4/6 to 10/ 12/14/16/24/25/30/31
	with Data Buffer	No	
	with Range Comparator	Yes	
	with Scan Disable	No	
	with ADC Pulse Detection	No	
16-bit Reload Timer (RLT)		3ch	RLT 1/3/6
16-bit Free-Running Timer (FRT)		4ch	FRT 0 to 3 FRT 0 to 3 does not have external clock input pin
16-bit Input Capture Unit (ICU)		7ch (3 channels for LIN-USART)	ICU 0/1/4 to 6/9/10 (ICU 6/9/10 for LIN-USART)
16-bit Output Compare Unit (OCU)		5ch	OCU 0/1/4/6/7 (OCU 4 for FRT clear)
8/16-bit Programmable Pulse Generator (PPG)		8ch (16-bit) / 16ch (8-bit)	PPG 0/1/3/4/6/7/12/14
	with Timing point capture	Yes	
	with Start delay	No	
	with Ramp	No	
Quadrature Position/Revolution Counter (QPRC)		2ch	QPRC 0/1
CAN Interface		1ch	CAN 2 32 Message Buffers
External Interrupts (INT)		11ch	INT 0/2/3/4/7 to 13
Non-Maskable Interrupt (NMI)		1ch	
Real Time Clock (RTC)		1ch	
I/O Ports		35 (Dual clock mode) 37 (Single clock mode)	
Clock Calibration Unit (CAL)		1ch	
Clock Output Function		2ch	
Low Voltage Detection Function		Yes	Low voltage detection function can be disabled by software
Hardware Watchdog Timer		Yes	
On-chip RC-oscillator		Yes	
On-chip Debugger		Yes	

Note:

- *All signals of the peripheral function in each product cannot be allocated by limiting the pins of package. It is necessary to use the port relocate function of the general I/O port according to your function use.*

Pin Name	Feature	Description
ZINn	QPRC	Quadrature Position/Revolution Counter Unit n input pin

5. Pin Circuit Type

Pin No.	I/O Circuit Type*	Pin Name
1	Supply	AVss
2	G	AVRH
3	K	P06_3 / AN3 / PPG3
4	K	P06_4 / AN4 / PPG4
5	K	P06_6 / AN6 / PPG6
6	K	P06_7 / AN7 / PPG7
7	I	P05_0 / AN8 / SIN2 / INT3_R1
8	K	P05_1 / AN9 / SOT2
9	I	P05_2 / AN10 / SCK2
10	K	P05_4 / AN12 / TOT3 / INT2_R
11	K	P05_6 / AN14 / INT4_R
12	K	P07_0 / AN16 / INT0 / NMI
13	B	P04_0 / X0A
14	B	P04_1 / X1A
15	C	MD
16	H	P17_0
17	O	DEBUG I/F
18	M	P00_0 / INT8 / SCK7_R / PPG0_B
19	H	P00_1 / INT9 / SOT7_R / PPG1_B
20	M	P00_2 / INT10 / SIN7_R
21	H	P00_4 / INT12 / SOT8_R / PPG12_B
22	M	P00_5 / INT13 / SIN8_R / PPG14_B
23	M	P00_3 / INT11 / SCK8_R / PPG3_B
24	H	P01_0 / TIN1 / CKOT1 / OUT0_R
25	H	P01_1 / TOT1 / CKOTX1 / OUT1_R
26	H	P01_4 / PPG4_B
27	M	P01_5 / SIN2_R / INT7_R
28	H	P01_6 / SOT2_R / PPG6_B
29	M	P01_7 / SCK2_R / PPG7_B
30	H	P02_0 / PPG12 / CKOT1_R
31	H	P02_2 / ZIN0 / PPG14 / CKOT0_R
32	H	P02_4 / AIN0 / IN0 / TTG0

Pin No.	I/O Circuit Type*	Pin Name
33	C	RSTX
34	A	X1
35	A	X0
36	Supply	Vss
37	Supply	Vcc
38	F	C
39	H	P02_5 / BIN0 / IN1 / TTG1 / ADTG_R
40	K	P03_0 / AIN1 / IN4 / TTG4 / TTG12 / AN24
41	K	P03_1 / BIN1 / IN5 / TTG5 / TTG13 / AN25
42	M	P03_2 / INT10_R / RX2
43	H	P03_3 / TX2
44	K	P03_6 / ZIN1 / OUT6 / AN30
45	K	P03_7 / OUT7 / AN31
46	K	P06_0 / AN0 / PPG0
47	K	P06_1 / AN1 / PPG1
48	Supply	AVcc

*: See I/O Circuit Type" for details on the I/O circuit types.

8. RAMstart Addresses

Devices	Bank 0 RAM Size	RAMSTART0
CY96F612	4KB	$00:7200_H$
CY96F613, CY96F615	10KB	$00:5A00_H$

Vector Number	Offset in Vector Table	Vector Name	Cleared by DMA	Index in ICR to Program	Description
40	$35C_H$	-	-	40	Reserved
41	358_H	PPG3	Yes	41	Programmable Pulse Generator 3
42	354_H	PPG4	Yes	42	Programmable Pulse Generator 4
43	350_H	-	-	43	Reserved
44	$34C_H$	PPG6	Yes	44	Programmable Pulse Generator 6
45	348_H	PPG7	Yes	45	Programmable Pulse Generator 7
46	344_H	-	-	46	Reserved
47	340_H	-	-	47	Reserved
48	$33C_H$	-	-	48	Reserved
49	338_H	-	-	49	Reserved
50	334_H	PPG12	Yes	50	Programmable Pulse Generator 12
51	330_H	-	-	51	Reserved
52	$32C_H$	PPG14	Yes	52	Programmable Pulse Generator 14
53	328_H	-	-	53	Reserved
54	324_H	-	-	54	Reserved
55	320_H	-	-	55	Reserved
56	$31C_H$	-	-	56	Reserved
57	318_H	-	-	57	Reserved
58	314_H	-	-	58	Reserved
59	310_H	RLT1	Yes	59	Reload Timer 1
60	$30C_H$	-	-	60	Reserved
61	308_H	RLT3	Yes	61	Reload Timer 3
62	304_H	-	-	62	Reserved
63	300_H	-	-	63	Reserved
64	$2FC_H$	RLT6	Yes	64	Reload Timer 6
65	$2F8_H$	ICU0	Yes	65	Input Capture Unit 0
66	$2F4_H$	ICU1	Yes	66	Input Capture Unit 1
67	$2F0_H$	-	-	67	Reserved
68	$2EC_H$	-	-	68	Reserved
69	$2E8_H$	ICU4	Yes	69	Input Capture Unit 4
70	$2E4_H$	ICU5	Yes	70	Input Capture Unit 5
71	$2E0_H$	ICU6	Yes	71	Input Capture Unit 6
72	$2DC_H$	-	-	72	Reserved
73	$2D8_H$	-	-	73	Reserved
74	$2D4_H$	ICU9	Yes	74	Input Capture Unit 9
75	$2D0_H$	ICU10	Yes	75	Input Capture Unit 10
76	$2CC_H$	-	-	76	Reserved
77	$2C8_H$	OCU0	Yes	77	Output Compare Unit 0
78	$2C4_H$	OCU1	Yes	78	Output Compare Unit 1
79	$2C0_H$	-	-	79	Reserved
80	$2BC_H$	-	-	80	Reserved

Vector Number	Offset in Vector Table	Vector Name	Cleared by DMA	Index in ICR to Program	Description
81	$2B8_H$	OCU4	Yes	81	Output Compare Unit 4
82	$2B4_H$	-	-	82	Reserved
83	$2B0_H$	OCU6	Yes	83	Output Compare Unit 6
84	$2AC_H$	OCU7	Yes	84	Output Compare Unit 7
85	$2A8_H$	-	-	85	Reserved
86	$2A4_H$	-	-	86	Reserved
87	$2A0_H$	-	-	87	Reserved
88	$29C_H$	-	-	88	Reserved
89	298_H	FRT0	Yes	89	Free-Running Timer 0
90	294_H	FRT1	Yes	90	Free-Running Timer 1
91	290_H	FRT2	Yes	91	Free-Running Timer 2
92	$28C_H$	FRT3	Yes	92	Free-Running Timer 3
93	288_H	RTC0	No	93	Real Time Clock
94	284_H	CAL0	No	94	Clock Calibration Unit
95	280_H	-	-	95	Reserved
96	$27C_H$	-	-	96	Reserved
97	278_H	-	-	97	Reserved
98	274_H	ADC0	Yes	98	A/D Converter 0
99	270_H	-	-	99	Reserved
100	$26C_H$	-	-	100	Reserved
101	268_H	-	-	101	Reserved
102	264_H	-	-	102	Reserved
103	260_H	-	-	103	Reserved
104	$25C_H$	-	-	104	Reserved
105	258_H	LINR2	Yes	105	LIN USART 2 RX
106	254_H	LINT2	Yes	106	LIN USART 2 TX
107	250_H	-	-	107	Reserved
108	$24C_H$	-	-	108	Reserved
109	248_H	-	-	109	Reserved
110	244_H	-	-	110	Reserved
111	240_H	-	-	111	Reserved
112	$23C_H$	-	-	112	Reserved
113	238_H	-	-	113	Reserved
114	234_H	-	-	114	Reserved
115	230_H	LINR7	Yes	115	LIN USART 7 RX
116	$22C_H$	LINT7	Yes	116	LIN USART 7 TX
117	228_H	LINR8	Yes	117	LIN USART 8 RX
118	224_H	LINT8	Yes	118	LIN USART 8 TX
119	220_H	-	-	119	Reserved
120	$21C_H$	-	-	120	Reserved
121	218_H	-	-	121	Reserved

12.3 Precautions for Use Environment

Reliability of semiconductor devices depends on ambient temperature and other conditions as described above.

For reliable performance, do the following:

1. Humidity

Prolonged use in high humidity can lead to leakage in devices as well as printed circuit boards. If high humidity levels are anticipated, consider anti-humidity processing.

2. Discharge of Static Electricity

When high-voltage charges exist close to semiconductor devices, discharges can cause abnormal operation. In such cases, use anti-static measures or processing to prevent discharges.

3. Corrosive Gases, Dust, or Oil

Exposure to corrosive gases or contact with dust or oil may lead to chemical reactions that will adversely affect the device. If you use devices in such conditions, consider ways to prevent such exposure or to protect the devices.

4. Radiation, Including Cosmic Radiation

Most devices are not designed for environments involving exposure to radiation or cosmic radiation. Users should provide shielding as appropriate.

5. Smoke, Flame

CAUTION:

Plastic molded devices are flammable, and therefore should not be used near combustible substances. If devices begin to smoke or burn, there is danger of the release of toxic gases.

Customers considering the use of Cypress products in other special environmental conditions should consult with sales representatives.

13. Handling Devices

Special Care is Required for the Following when Handling the Device:

- Latch-up prevention
- Unused pins handling
- External clock usage
- Notes on PLL clock mode operation
- Power supply pins (Vcc/Vss)
- Crystal oscillator and ceramic resonator circuit
- Turn on sequence of power supply to A/D converter and analog inputs
- Pin handling when not using the A/D converter
- Notes on Power-on
- Stabilization of power supply voltage
- Serial communication
- Mode Pin (MD)

13.1 Latch-Up Prevention

CMOS IC chips may suffer latch-up under the following conditions:

- A voltage higher than V_{CC} or lower than V_{SS} is applied to an input or output pin.
- A voltage higher than the rated voltage is applied between Vcc pins and Vss pins.
- The AV_{CC} power supply is applied before the V_{CC} voltage.

Latch-up may increase the power supply current dramatically, causing thermal damages to the device.

For the same reason, extra care is required to not let the analog power-supply voltage (AV_{CC}, AVRH) exceed the digital power-supply voltage.

13.2 Unused Pins Handling

Unused input pins can be left open when the input is disabled (corresponding bit of Port Input Enable register PIER = 0).

Leaving unused input pins open when the input is enabled may result in misbehavior and possible permanent damage of the device. To prevent latch-up, they must therefore be pulled up or pulled down through resistors which should be more than 2kΩ.

Unused bidirectional pins can be set either to the output state and be then left open, or to the input state with either input disabled or external pull-up/pull-down resistor as described above.

13.3 External Clock Usage

The permitted frequency range of an external clock depends on the oscillator type and configuration.

See

13.7 Turn on Sequence of Power Supply to A/D Converter and Analog Inputs

It is required to turn the A/D converter power supply (AV_{CC}, AVRH) and analog inputs (ANn) on after turning the digital power supply (V_{CC}) on.

It is also required to turn the digital power off after turning the A/D converter supply and analog inputs off. In this case, AVRH must not exceed AV_{CC} Input voltage for ports shared with analog input ports also must not exceed AV_{CC} (turning the analog and digital power supplies simultaneously on or off is acceptable)

13.8 Pin Handling when Not Using the A/D Converter

If the A/D converter is not used, the power supply pins for A/D converter should be connected such as AV_{CC} = V_{CC} AV_{SS} = AVRH = V_{SS}.

13.9 Notes on Power-on

To prevent malfunction of the internal voltage regulator, supply voltage profile while turning the power supply on should be slower than 50µs from 0.2V to 2.7V.

13.10 Stabilization of Power Supply Voltage

If the power supply voltage varies acutely even within the operation safety range of the V_{CC} power supply voltage, a malfunction may occur. The V_{CC} power supply voltage must therefore be stabilized. As stabilization guidelines, the power supply voltage must be stabilized in such a way that V_{CC} ripple fluctuations (peak to peak value) in the commercial frequencies (50Hz to 60Hz) fall within 10% of the standard V_{CC} power supply voltage and the transient fluctuation rate becomes 0.1V/µs or less in instantaneous fluctuation for power supply switching.

13.11 Serial Communication

There is a possibility to receive wrong data due to noise or other causes on the serial communication.

Therefore, design a printed circuit board so as to avoid noise.

Consider receiving of wrong data when designing the system. For example apply a checksum and retransmit the data if an error occurs.

13.12 Mode Pin (MD)

Connect the mode pin directly to Vcc or Vss pin. To prevent the device unintentionally entering test mode due to noise, lay out the printed circuit board so as to minimize the distance from the mode pin to Vcc or Vss pin and provide a low-impedance connection.

14.3.2 *Pin Characteristics*

(V_{CC} = AV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = 0V, T_A = - 40°C to + 125°C)

Parameter	Symbol	Pin Name	Conditions	Value			Unit	Remarks
				Min	Typ	Max		
"H" level input voltage	V_{IH}	Port inputs Pnn_m	-	V_{CC}×0.7	-	V_{CC}+ 0.3	V	CMOS Hysteresis input
			-	V_{CC}×0.8	-	V_{CC}+ 0.3	V	AUTOMOTIVE Hysteresis input
	V_{IHX0S}	X0	External clock in "Fast Clock Input mode"	VD×0.8	-	VD	V	VD=1.8V±0.15V
	V_{IHX0AS}	X0A	External clock in "Oscillation mode"	V_{CC}×0.8	-	V_{CC}+ 0.3	V	
	V_{IHR}	RSTX	-	V_{CC}×0.8	-	V_{CC}+ 0.3	V	CMOS Hysteresis input
	V_{IHM}	MD	-	V_{CC}- 0.3	-	V_{CC}+ 0.3	V	CMOS Hysteresis input
	V_{IHD}	DEBUG I/F	-	2.0	-	V_{CC}+ 0.3	V	TTL Input
"L" level input voltage	V_{IL}	Port inputs Pnn_m	-	V_{SS}- 0.3	-	V_{CC}×0.3	V	CMOS Hysteresis input
			-	V_{SS}- 0.3	-	V_{CC}×0.5	V	AUTOMOTIVE Hysteresis input
	V_{ILX0S}	X0	External clock in "Fast Clock Input mode"	V_{SS}	-	VD×0.2	V	VD=1.8V±0.15V
	V_{ILX0AS}	X0A	External clock in "Oscillation mode"	V_{SS}- 0.3	-	V_{CC}×0.2	V	
	V_{ILR}	RSTX	-	V_{SS}- 0.3	-	V_{CC}×0.2	V	CMOS Hysteresis input
	V_{ILM}	MD	-	V_{SS}- 0.3	-	V_{SS}+ 0.3	V	CMOS Hysteresis input
	V_{ILD}	DEBUG I/F	-	V_{SS}- 0.3	-	0.8	V	TTL Input
"H" level output voltage	V_{OH4}	4mA type	4.5V ≤ V_{CC} ≤ 5.5V I_{OH} = -4mA	V_{CC}- 0.5	-	V_{CC}	V	
			2.7V ≤ V_{CC} < 4.5V I_{OH} = -1.5mA					
"L" level output voltage	V_{OL4}	4mA type	4.5V ≤ V_{CC} ≤ 5.5V I_{OL} = +4mA	-	-	0.4	V	
			2.7V ≤ V_{CC} < 4.5V I_{OL} = +1.7mA					
	V_{OLD}	DEBUG I/F	V_{CC} = 2.7V I_{OL} = +25mA	0	-	0.25	V	
Input leak current	I_{IL}	Pnn_m	V_{SS} < V_I < V_{CC} AV_{SS} < V_I <AV_{CC}, AVRH	- 1	-	+ 1	µA	
Pull-up resistance value	R_{PU}	Pnn_m	V_{CC} = 5.0V ±10%	25	50	100	kΩ	
Input capacitance	C_{IN}	Other than C, Vcc, Vss, AVcc, AVss, AVRH	-	-	5	15	pF	

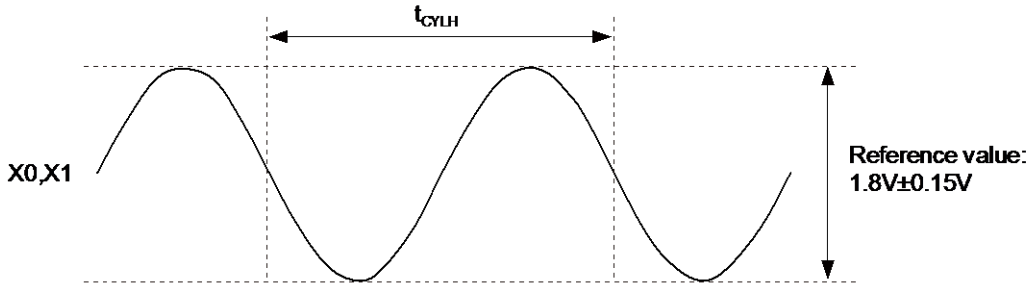
14.4 AC Characteristics

14.4.1 *Main Clock Input Characteristics*

(V_{CC} = AV_{CC} = 2.7V to 5.5V, VD=1.8V±0.15V, V_{SS} = AV_{SS} = 0V, T_A = - 40°C to + 125°C)

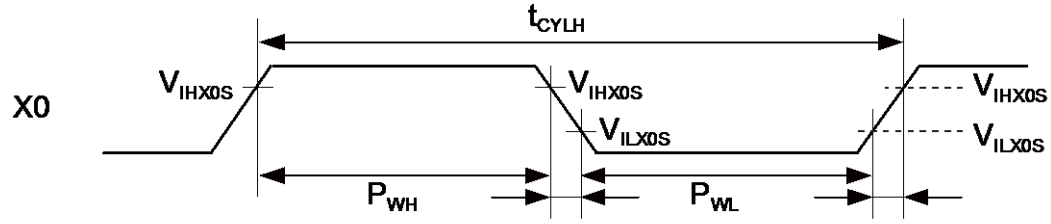
Parameter	Symbol	Pin Name	Value			Unit	Remarks
			Min	Typ	Max		
Input frequency	f_C	X0, X1	4	-	8	MHz	When using a crystal oscillator, PLL off
			-	-	8	MHz	When using an opposite phase external clock, PLL off
			4	-	8	MHz	When using a crystal oscillator or opposite phase external clock, PLL on
Input frequency	f_{FCI}	X0	-	-	8	MHz	When using a single phase external clock in “Fast Clock Input mode”, PLL off
			4	-	8	MHz	When using a single phase external clock in “Fast Clock Input mode”, PLL on
Input clock cycle	t_{CYLH}	-	125	-	-	ns	
Input clock pulse width	P_{WH}, P_{WL}	-	55	-	-	ns	

When using the crystal oscillator



The amplitude changes by resistance, capacity which added outside or the difference of the device.

When using the external clock



14.4.8 *USART Timing*

(V_{CC} = AV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = 0V, T_A = - 40°C to + 125°C, C_L=50pF)

Parameter	Symbol	Pin name	Conditions	4.5V ≤ V_{CC} <5.5V		2.7V ≤ V_{CC} <4.5V		Unit
				Min	Max	Min	Max	
Serial clock cycle time	t_{SCYC}	SCKn	Internal shift clock mode	$4t_{CLKP1}$	-	$4t_{CLKP1}$	-	ns
SCK ↓ →SOT delay time	t_{SLOVI}	SCKn, SOTn		- 20	+ 20	- 30	+ 30	ns
SOT → SCK ↑ delay time	t_{OVSHI}	SCKn, SOTn		$N \times t_{CLKP1} - 20^*$	-	$N \times t_{CLKP1} - 30^*$	-	ns
SIN → SCK ↑ setup time	t_{IVSHI}	SCKn, SINn		t_{CLKP1}+ 45	-	t_{CLKP1} + 55	-	ns
SCK ↑ → SIN hold time	t_{SHIXI}	SCKn, SINn		0	-	0	-	ns
Serial clock "L" pulse width	t_{SLSH}	SCKn	External shift clock mode	t_{CLKP1}+ 10	-	t_{CLKP1} + 10	-	ns
Serial clock "H" pulse width	t_{SHSL}	SCKn		t_{CLKP1}+ 10	-	t_{CLKP1} + 10	-	ns
SCK ↓ → SOT delay time	t_{SLOVE}	SCKn, SOTn		-	$2t_{CLKP1}$ + 45	-	$2t_{CLKP1}$ + 55	ns
SIN → SCK ↑ setup time	t_{IVSHE}	SCKn, SINn		t_{CLKP1}/2+ 10	-	t_{CLKP1}/2 + 10	-	ns
SCK ↑ → SIN hold time	t_{SHIXE}	SCKn, SINn		t_{CLKP1}+ 10	-	t_{CLKP1} + 10	-	ns
SCK fall time	t_F	SCKn		-	20	-	20	ns
SCK rise time	t_R	SCKn		-	20	-	20	ns

Notes:

- *AC characteristic in CLK synchronized mode*
- *C_L is he load capacity value of pins when testing.*
- *Depending on the used machine clock frequency, the maximum possible baud rate can be limited by some parameters. These parameters are shown in "CY96600 series HARDWARE MANUAL".*
- *t_{CLKP1} indicates the peripheral clock 1 (CLKP1), Unit: ns*
  These characteristics only guarantee the same relocate port number.

For example, the combination of SCKn and SOTn_R is not guaranteed.

*: Parameter N depends on t_{SCYC} and can be calculated as follows:

- If $t_{SCYC} = 2 \times k \times t_{CLKP1}$, then N = k, where k is an integer > 2
- If $t_{SCYC} = (2 \times k + 1) \times t_{CLKP1}$, then N = k + 1, where k is an integer > 1

Examples:

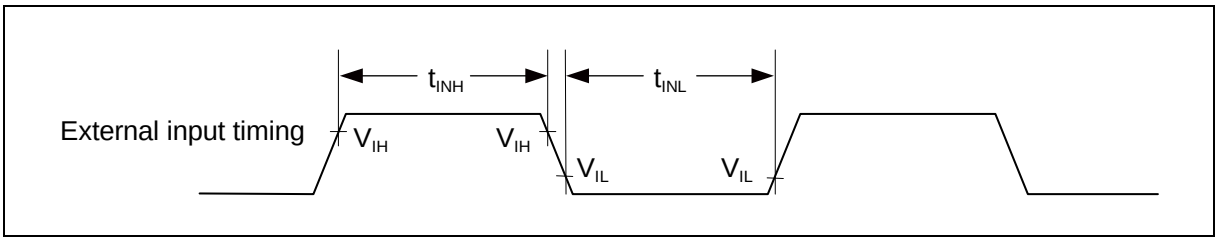
t_{SCYC}	N
$4 \times t_{CLKP1}$	2
$5 \times t_{CLKP1}$, $6 \times t_{CLKP1}$	3
$7 \times t_{CLKP1}$, $8 \times t_{CLKP1}$	4

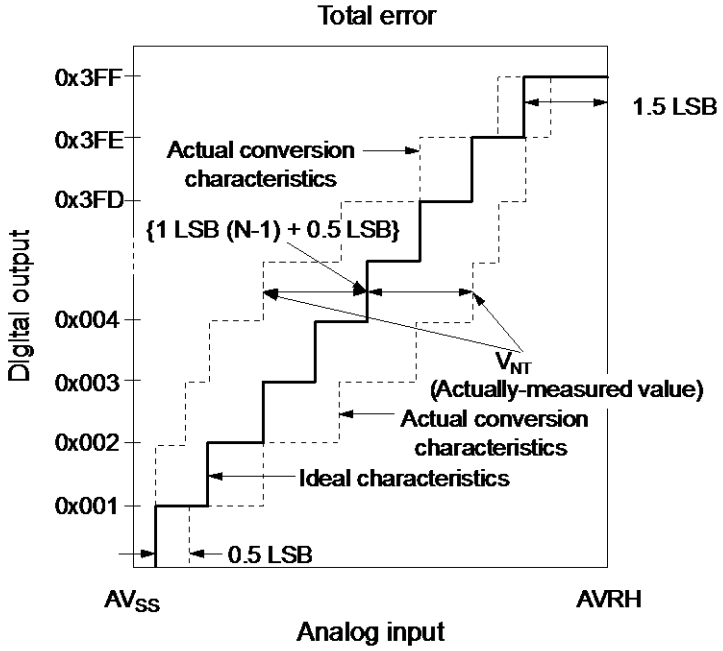
14.4.9 *External Input Timing*

(V_{CC} = AV_{CC} = 2.7V to 5.5V, V_{SS} = AV_{SS} = 0V, T_A = - 40°C to + 125°C)

Parameter	Symbol	Pin Name	Value		Unit	Remarks
			Min	Max		
Input pulse width	t_{INH}, t_{INL}	Pnn_m	$2t_{CLKP1}$ +200 (t_{CLKP1}=1/f_{CLKP1})*	-	ns	General Purpose I/O
		ADTG_R				A/D Converter trigger input
		TINn				Reload Timer
		TTGn				PPG trigger input
		INn				Input Capture
		AINn, BINn, ZINn				Quadrature Position/Revolution Counter
		INTn, INTn_R, INTn_R1	200	-	ns	External Interrupt
		NMI				Non-Maskable Interrupt

*: t_{CLKP1} indicates the peripheral clock1 (CLKP1) cycle time except stop when in stop mode.





$$1LSB\ (Ideal\ value) = \frac{AVRH - AV_{SS}}{1024}\ [V]$$

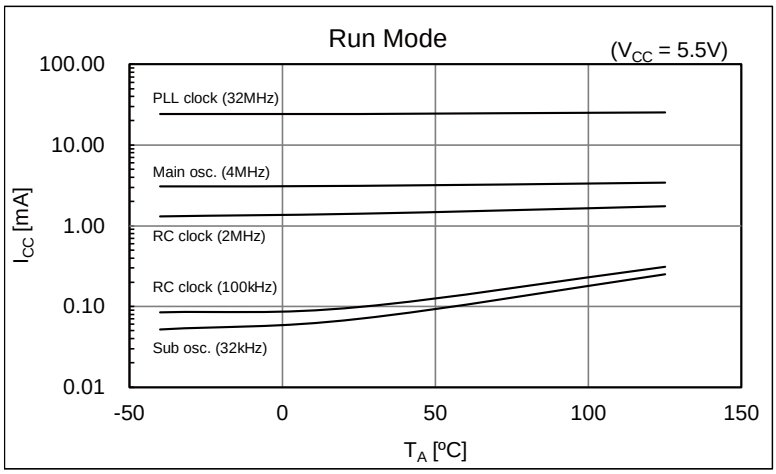
$$Total\ error\ of\ digital\ output\ N = \frac{V_{NT} - \{1LSB \times (N - 1) + 0.5LSB\}}{1LSB}$$

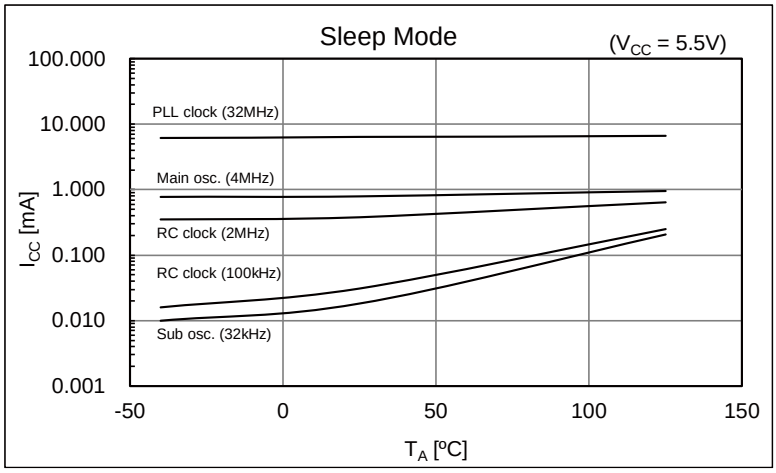
N : A/D converter digital output value.
V_{NT} : Voltage at which the digital output changes from 0x(N + 1) to 0xN.
V_{OT} (Ideal value) = AV_{SS} + 0.5LSB[V]
V_{FST} (Ideal value) = AVRH - 1.5LSB[V]

15. Example Characteristics

This characteristic is an actual value of the arbitrary sample. It is not the guaranteed value.

CY96F615





Page	Section	Change Results
58	16. Ordering Information	Revised Marketing Part Numbers as follows: Before) **MCU with CAN Controller** MB96F612RBPMC-GSE1 MB96F612RBPMC-GS-UJE1 MB96F612RBPMC-GSE2 MB96F612RBPMC-GS-UJE2 MB96F612RBPMC-GTE1 MB96F613RBPMC-GSE1 MB96F613RBPMC-GS-UJE1 MB96F613RBPMC-GSE2 MB96F613RBPMC-GS-UJE2 MB96F613RBPMC-GTE1 MB96F615RBPMC-GSE1 MB96F615RBPMC-GS-UJE1 MB96F615RBPMC-GSE2 MB96F615RBPMC-GS-UJE2 MB96F615RBPMC-GTE1 **MCU without CAN Controller** MB96F612ABPMC-GSE1 MB96F612ABPMC-GS-UJE1 MB96F612ABPMC-GSE2 MB96F612ABPMC-GS-UJE2 MB96F612ABPMC-GTE1 MB96F613ABPMC-GSE1 MB96F613ABPMC-GS-UJE1 MB96F613ABPMC-GSE2 MB96F613ABPMC-GS-UJE2 MB96F613ABPMC-GTE1 MB96F615ABPMC-GSE1 MB96F615ABPMC-GS-UJE1 MB96F615ABPMC-GSE2 MB96F615ABPMC-GTE1
58	16. Ordering Information	After) **MCU with CAN Controller** CY96F612RBPMC-GS-UJE1 CY96F612RBPMC-GS-UJE2 CY96F613RBPMC-GS-UJE1 CY96F613RBPMC-GS-UJE2 CY96F613RBPMC-GS-UJERE2 CY96F615RBPMC-GS-UJE1 CY96F615RBPMC-GS-UJE2 CY96F615RBPMC-GS-UJERE2 **MCU without CAN Controller** CY96F612ABPMC-GS-UJE1 CY96F612ABPMC-GS-UJE2 CY96F613ABPMC-GS-UJE1 CY96F613ABPMC-GS-UJE2 CY96F615ABPMC-GS-UJE1

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